L Number	Hits	Search Text	DB	Time stamp
	1	("5131963").PN.	USPAT	2004/08/02 15:55
2	1	(("5131963").PN.) and (solid or diamond or integrated or	USPAT	2004/08/02 16:09
		circuit or die or dice or plurality or monocrystalline or		
		semiconductor or material or surface or ion or material or		
		solid or semiconductor or implanting or implantation or		
_		combination or wafer or substrate)	LICDAT	0004/00/00 17 07
3	1		USPAT	2004/08/02 16:07
4	ļ		USPAT	2004/08/02 16:07 2004/08/02 16:08
5	l		USPAT USPAT	
6		114047 E2011 DNI and (solid or diamond or integrated or	USPAT	2004/08/02 16:08 2004/08/02 16:33
′	1	"4863529".PN. and (solid or diamond or integrated or circuit or die or dice or plurality or monocrystalline or	usrAi	2004/06/02 10:33
		semiconductor or material or surface or ion or material or	İ	
		solid or semiconductor or implanting or implantation or		
		combination or wafer or substrate)		
8	1	("6337513").PN.	USPAT	2004/08/02 16:33
9	i	(("6337513").PN.) and (solid or diamond or integrated or	USPAT	2004/08/02 16:33
,	•	circuit or die or dice or plurality or monocrystalline or	43,711	200 0002
	1	semiconductor or material or surface or ion or material or		
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		combination or wafer or substrate)		
-	1	09/920275	USPAT	2004/07/31 09:04
-	1	09/920275 and (solid or diamond or integrated or circuit	USPAT	2004/07/31 09:45
		or die or dice or plurality or monocrystalline or		
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-	0	("6770966").PN.	USPAT	2004/07/31 09:40
-	0	CVDD and diamond and die and integrated and circuit and	USPAT	2004/07/31 09:43
		plurality and monocrystalline and solid		
-	26		USPAT	2004/07/31 09:43
		plurality and monocrystalline and solid		2004/07/74 20 44
-	0	CVD and diamond and die and integrated and circuit and	USPAT	2004/07/31 09:44
		plurality and monocrystalline and solid and (solid adj		
		diamond) and (monocrystalline adj semiconductor adj		
		material)	USPAT	2004/07/31 09:44
-	0		USPAT	2004/07/31 09:44
		plurality and monocrystalline and solid and (solid adj diamond) and (semiconductor adj material)		
_	0	CVD and diamond and die and integrated and circuit and	USPAT	2004/07/31 09:44
_		plurality and monocrystalline and solid and (solid adj	4317(1	200 1707751 07111
		diamond) and material		
l _	26	l .	USPAT	2004/07/31 10:31
		plurality and monocrystalline and solid) and (solid or		
		diamond or integrated or circuit or die or dice or plurality or		
		monocrystalline or semiconductor or material or surface or		
		ion or material or solid or semiconductor or implanting or		
		implantation)		
-	1	("5904546").PN.	USPAT	2004/07/31 10:30
-	1	(USPAT	2004/08/02 15:56
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		semiconductor or material or surface or ion or material or		
		solid or semiconductor or implanting or implantation)		
-	1	("5834334").PN.	USPAT	2004/07/31 10:31
•	1	1 (()	USPAT	2004/07/31 10:32
		circuit or die or dice or plurality or monocrystalline or		
		semiconductor or material or surface or ion or material or		
		solid or semiconductor or implanting or implantation)	LICDAT	2004/07/71 10:72
•	!	("5946559").PN.	USPAT USPAT	2004/07/31 10:32 2004/07/31 10:32
•	1	(("5946559").PN.) and (solid or diamond or integrated or	usrAl	2007/07/31 10:32
		circuit or die or dice or plurality or monocrystalline or semiconductor or material or surface or ion or material or		
		solid or semiconductor or implanting or implantation)		
	<u> </u>	4.38.51 PM Page 1		

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•	1	("6110278").PN.	USPAT	2004/07/31 10:32
-	1	(("6110278").PN.) and (solid or diamond or integrated or	USPAT	2004/07/31 10:32
		circuit or die or dice or plurality or monocrystalline or		
		semiconductor or material or surface or ion or material or		
		solid or semiconductor or implanting or implantation)		
-	380	438/33	USPAT	2004/07/31 10:32
•	252	438/68	USPAT	2004/07/31 10:33
-	2486	438/106	USPAT	2004/07/31 10:33
-	1030	438/113	USPAT	2004/07/31 10:33
-	848	438/460	USPAT	2004/07/31 10:33
•	793	438/462	USPAT	2004/07/31 10:33
•	619	438/464	USPAT	2004/07/31 10:33
•	159	438/475	USPAT	2004/07/31 10:33
•	179	438/474	USPAT	2004/07/31 10:33
•	236	438/473	USPAT	2004/07/31 10:33
•	1046	438/680	USPAT	2004/07/31 10:34
-	356	438/931	USPAT	2004/07/31 10:34